

**3N128**

**SILICON N-CHANNEL  
MOS FIELD-EFFECT TRANSISTOR**

... designed for VHF amplifier and oscillator applications in communications equipment.

- High Forward Transadmittance –  
 $|y_{fs}| = 5000 \mu\text{mhos (Min) @ } f = 1.0 \text{ kHz}$
- Low Input Capacitance –  
 $C_{iss} = 7.0 \text{ pF (Max) @ } f = 1.0 \text{ MHz}$
- Low Noise Figure –  
 $\text{NF} = 5.0 \text{ dB (Max) @ } f = 200 \text{ MHz}$
- High Power Gain –  
 $P_G = 13.5 \text{ dB (Min) @ } f = 200 \text{ MHz}$
- Complete "y" Parameter Curves
- Third Order Intermodulation Distortion Performance Curve Provided

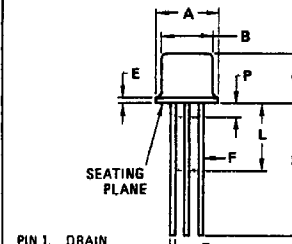
**N-CHANNEL  
MOS FIELD-EFFECT  
TRANSISTOR**



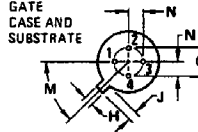
**\* MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	+20	Vdc
Drain-Gate Voltage	$V_{DG}$	+20	Vdc
Gate-Source Voltage	$V_{GS}$	$\pm 10$	Vdc
Drain Current	$I_D$	50	mAdc
Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	330 2.2	mW mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +175	$^\circ\text{C}$

\*Indicates JEDEC Registered Data.



- PIN 1. DRAIN  
2. SOURCE  
3. GATE  
4. CASE AND SUBSTRATE



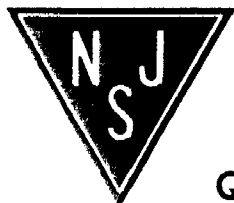
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.31	5.84	0.209	0.230
B	4.62	4.95	0.178	0.195
C	4.32	5.33	0.170	0.210
D	0.41	0.53	0.016	0.021
E	-	0.76	-	0.030
F	0.41	0.48	0.016	0.019
G	2.54 BSC		0.100 BSC	
H	0.91	1.17	0.036	0.046
J	0.71	1.22	0.028	0.048
K	12.70	-	0.500	-
L	6.35	-	0.250	-
M	45 $^\circ$ BSC		45 $^\circ$ BSC	
N	1.27 BSC		0.050 BSC	
P	-	1.27	-	0.050

(TO-72)

**HANDLING PRECAUTIONS**

MOS field-effect transistors have extremely high input resistance. They can be damaged by the accumulation of excess static charge. Avoid possible damage to the devices while handling, testing, or in actual operation, by following the procedures outlined below:

1. To avoid the build-up of static charge, the leads of the devices should remain shorted together with a metal ring except when being tested or used.
2. Avoid unnecessary handling. Pick up devices by the case instead of the leads.
3. Do not insert or remove devices from circuits with the power on because transient voltages may cause permanent damage to the devices.



NJ Semi-Conductors reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However, NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.

**\*ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Gate-Source Breakdown Voltage (1) ( $I_G = -10 \mu\text{Adc}$ , $V_{DS} = 0$ )	$V_{(BR)GSS}$	-50	—	Vdc
Gate-Source Cutoff Voltage ( $V_{DS} = 15 \text{Vdc}$ , $I_D = 50 \mu\text{Adc}$ )	$V_{GS(off)}$	-0.5	-8.0	Vdc
Gate Reverse Current ( $V_{GS} = -8.0 \text{Vdc}$ , $V_{DS} = 0$ ) ( $V_{GS} = -8.0 \text{Vdc}$ , $V_{DS} = 0$ , $T_A = 125^\circ\text{C}$ )	$I_{GSS}$	—	0.05 5.0	nAdc
<b>ON CHARACTERISTICS</b>				
Zero-Gate-Voltage Drain Current (2) ( $V_{DS} = 15 \text{Vdc}$ , $V_{GS} = 0$ )	$I_{DSS}$	5.0	25	mAdc
<b>SMALL-SIGNAL CHARACTERISTICS</b>				
Forward Transadmittance ( $V_{DS} = 15 \text{Vdc}$ , $I_D = 5.0 \text{mAdc}$ , $f = 1.0 \text{kHz}$ )	$ y_{fs} $	5000	12,000	$\mu\text{mhos}$
Forward Transconductance ( $V_{DS} = 15 \text{Vdc}$ , $I_D = 5.0 \text{mAdc}$ , $f = 200 \text{MHz}$ )	$\text{Re}(y_{fs})$	5000	—	$\mu\text{mhos}$
Output Conductance ( $V_{DS} = 15 \text{Vdc}$ , $I_D = 5.0 \text{mAdc}$ , $f = 200 \text{MHz}$ )	$\text{Re}(y_{os})$	—	500	$\mu\text{mhos}$
Input Conductance ( $V_{DS} = 15 \text{Vdc}$ , $I_D = 5.0 \text{mAdc}$ , $f = 200 \text{MHz}$ )	$\text{Re}(y_{is})$	—	800	$\mu\text{mhos}$
Input Capacitance ( $V_{DS} = 15 \text{Vdc}$ , $I_D = 5.0 \text{mAdc}$ , $f = 1.0 \text{MHz}$ )	$C_{iss}$	—	7.0	pF
Reverse Transfer Capacitance ( $V_{DS} = 15 \text{Vdc}$ , $I_D = 5.0 \text{mAdc}$ , $f = 1.0 \text{MHz}$ )	$C_{rss}$	0.05	0.35	pF
Noise Figure ( $V_{DS} = 15 \text{Vdc}$ , $I_D = 5.0 \text{mAdc}$ , $f = 200 \text{MHz}$ )	NF	—	5.0	dB
Power Gain ( $V_{DS} = 15 \text{Vdc}$ , $I_D = 5.0 \text{mAdc}$ , $f = 200 \text{MHz}$ )	$P_G$	13.5	23	dB

\*Indicates JEDEC Registered Data.

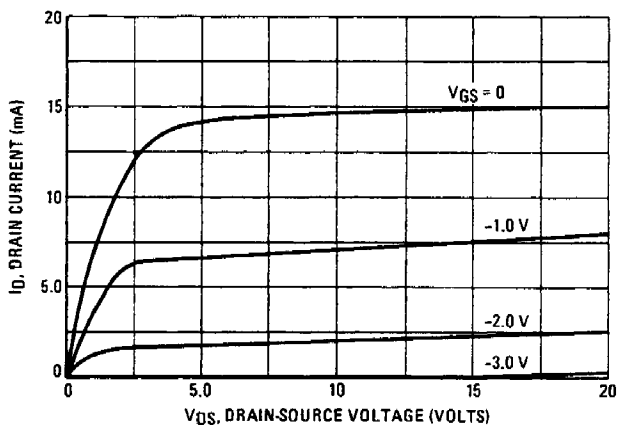
(1) Caution Destructive Test, can damage gate oxide beyond operation.

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2.0%.

**TYPICAL CHARACTERISTICS**

( $T_A = 25^\circ\text{C}$ )

**FIGURE 1 – DRAIN CHARACTERISTICS**



**FIGURE 2 – TRANSFER CHARACTERISTICS**

